# SG-FWLP-9-2

## Overview

### General Information

| | |
|---|---|
| Package Material | SG |
| Package Family | FWLP |
| Leads/Balls | 9 |
| Dash Version | 2 |

## Outline

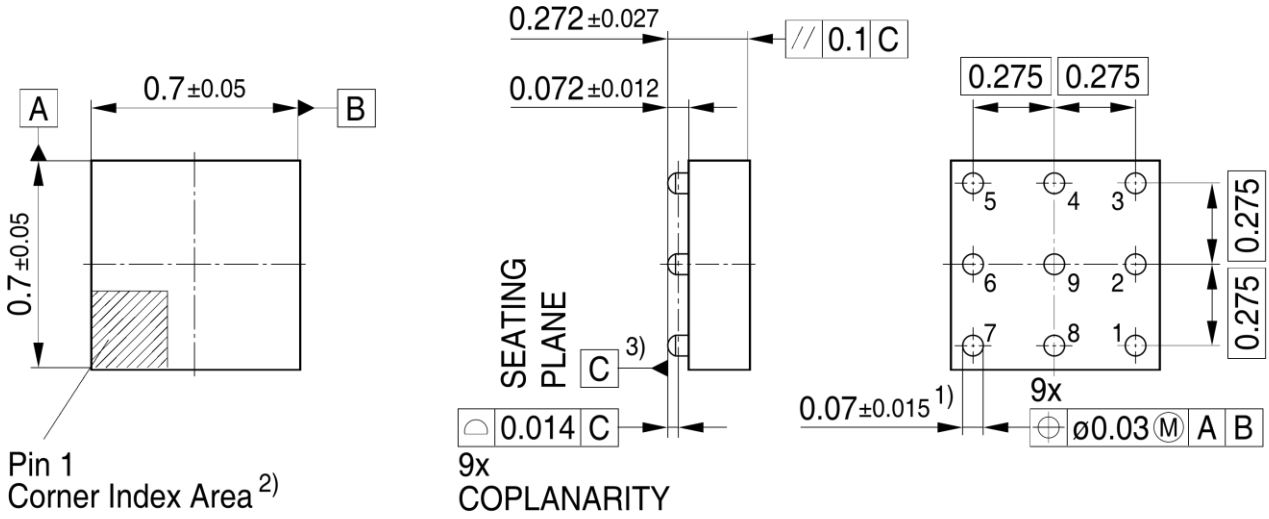
### Dimensions

| | |
|---|---|
| Body Length (mm) | 0.7050 |
| Body Width (mm) | 0.7050 |
| Lead/Ball Pitch (mm) | 0.2750 |

### Exposed Pad

| | |
|---|---|
| Heatslug | NONE |
| Exposed Paddle | NONE |

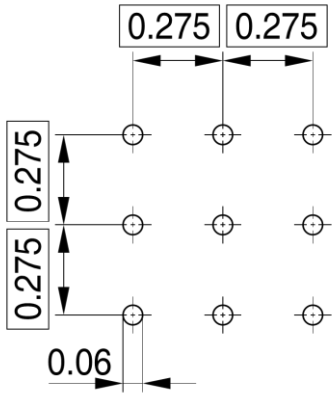
## Outline




1) Dimension is measured at the maximum solder ball diameter, parallel to primary datum C
2) Pin1 corner identified by marking
3) Primary datum C and seating plane are defined by the domed crowns of the balls

FWLP-9-2-PO V03

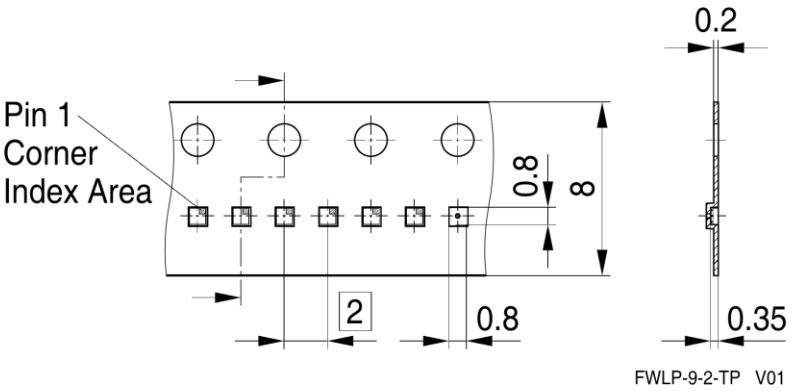
## Footprint Dimensions




FWLP-9-2-FP V03

# Packing

## Tape & Reel



**Edition 2016-04-11**

**Published by**

**Infineon Technologies AG**

**81726 München, Germany**

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